CXA1875AP/AM

8-bit D/A Converter Compatible with I2C Bus

Description

The CXA1875AP/AM is developed as a 8-bit 5 ch D/A converter compatible with I²C bus.

Features

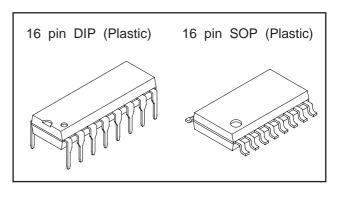
- Serial control through I2C bus
- 4 built-in general purpose I/O ports (Digital I/O)
- I/O can be specified to respective ports independently
- Selection of 8 slave addresses possible through address select pins (3 pins)

Applications

I²C bus can control ICs that do not correspond to I²C bus by connecting the DC control pins of them.

Structure

Bipolar silicon monolithic IC



Absolute Maximum Ratings (Ta=25°C)

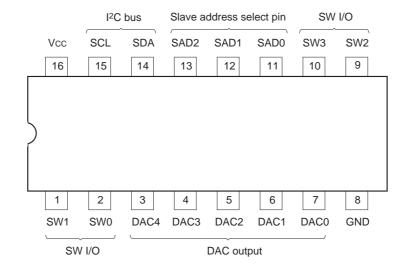
Vcc	7	V					
Topr	-20 to +75	°C					
Tstg	-65 to +150	°C					
Allowable power dissipation							
PD	960	mW					
	Topr Tstg ation	Topr -20 to +75 Tstg -65 to +150 ation					

Operating Conditions

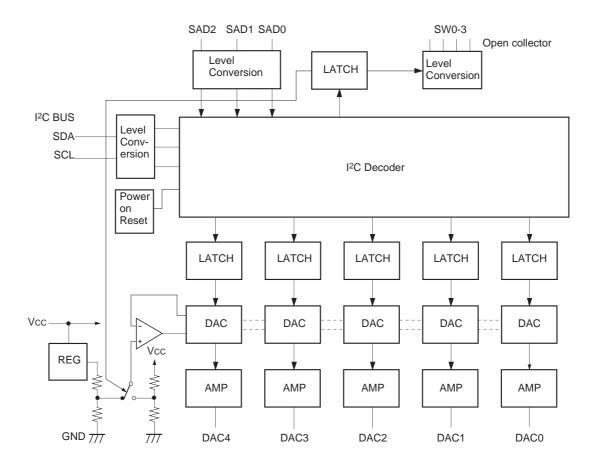
Supp	oly voltage	Vcc	5±0.5	V
• Ope	rating temperature	Topr	-20 to +7	5 °C

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Pin Configuration (Top View)



Block Diagram



Pin Description

No.	Symbol	Equivalent circuit	Description
1	SW1	Vçc	I/O pin for general purpose I/O port
2	SW0		VILmax: 1.5 V
9	SW2	<u> </u>	VIHmin: 3 V
10	SW3	150	Volmax: 0.4 V
14	SDA	* • • • • • • • • • • • • • • • • • • •	SDA I/O pin for I ² C bus
15	SCL	4.5k\$	
		Vcc	
3	DAC4	Vcc	
4	DAC3	<u> </u>	
5	DAC2	56 22k	D/A converter output pin
6	DAC1	₹20k	' '
7	DAC0		
		7 // 7	
8	GND		CND nin
8	GND		GND pin
		Vcc	Clave address input pip
11	SAD0	Vcc	Slave address input pin
12	SAD1	*	Input at positive logic
13	SAD2	150	VILmax: 1.5 V VIHmin: 3 V
			VIHITIIII. 3 V
		4.5k	
16	Vcc		Power supply pin

Electrical Characteristics (Ta=25 °C, Vcc=5 V)

D/A Converter Block

No.	Item	Symbol	Test circuit	Test contents	Min.	Тур.	Max.	Unit
1	Circuit current	Icc	1	DAC 0 to 4=127	6	9	12	mΑ

2	Differential linearity	DLE	1	V(DAC0 to 4=n+1)-V(DAC0 to 4=N) V(DAC0 to 4=191)-V(DAC0 to 4=63) n=0 to 127	-1	0	+1	LSB
3	Minimum output voltage	Vmin	1	DAC 0 to 4=0	0.1	0.4	0.7	V
4	Maximum output voltage	Vmax	1	DAC 0 to 4=255	4.3	4.6	4.9	V
5	Output current	lout	2	Current that can be flowed from Pins 3 to 7	-1		+1	mA
6	Output impedance	Zo	2	DAC 0 to 4=127, V(-1 mA) -V(1 mA) 2 mA	0	3	6	Ω

SW, SAD Pins

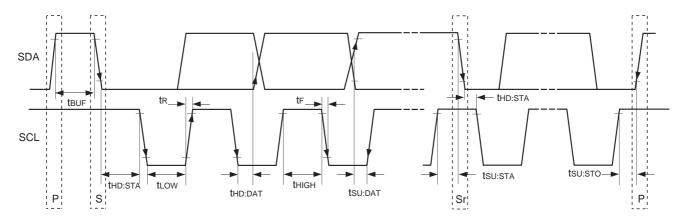
No.	Item	Symbol	Text circuit	Test contents	Min.	Тур.	Max.	Unit
7	Low level input voltage	VIL	3	ST 0 to 3 an input voltage that turns to '0'	_	_	1.5	V
8	High level input voltage	ViH	3	ST 0 to 3 an input voltage that turns to '1'	3.0	_	_	V
9	Low level input current	lıL	3	Input current when 0.4 V is applied	-10	0	+10	μA
10	High level input current	Іін	3	Input current when 4.5 V is applied	-10	0	+10	μA
11	Low level input voltage	Vol	4	SW 0 to 3=1, Output voltage when 1 mA flows in	0	0.2	0.4	V

I2C Bus Block Items (SDA, SCL)

No.	ltem	Symbol	Min.	Тур.	Max.	Unit
12	High level input voltage	ViH	3.0	_	5.0	V
13	Low level input voltage	VIL	0	_	1.5	V
14	High level input current	Іін	_	_	10	μA
15	Low level input current	liL	_	_	10	μA
16	Low level output voltage At 3 mA flow to SDA (Pin 14)	VoL	0	_	0.4	V
17	Maximum flowing current	loL	3	_	_	mA
18	Input capacitance	Cı	_	_	10	pF
19	Maximum clock frequency	fscL	0	_	100	kHz
20	Data change minimum waiting time	tBUF	4.7	_	_	μs
21	Data transfer start minimum waiting time	thd:sta	4.0	_	_	μs
22	Low level clock pulse width	tLOW	4.7	_	_	μs
23	High level clock pulse width	thigh	4.0	_	_	μs
24	Minimum start preparation waiting time	tsu:sta	4.7	_	_	μs
25	Minimum data hold time	thd:dat	5	_	_	μs
26	Minimum data preparation time	tsu:dat	250		_	ns
27	Rise time	tr			1	μs
28	Fall time	tr			300	ns
29	Minimum stop preparation waiting time	tsu:sto	4.7	_	_	μs

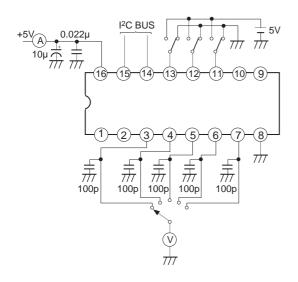
 $\mbox{I}^2\mbox{C}$ bus load conditions: Pull up resistance 4 k Ω (Connected to +5 V) Load capacitance 200 pF (Connected to GND)

I²C Bus Control Signal

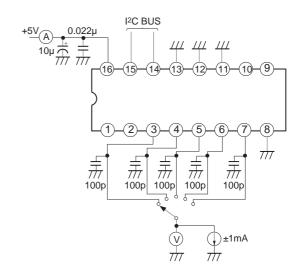


Electrical Characteristics Test Circuit

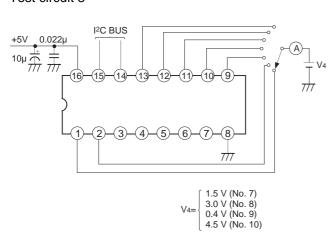
Test circuit 1



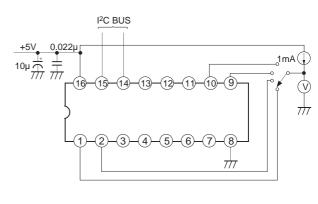
Test circuit 2



Test circuit 3

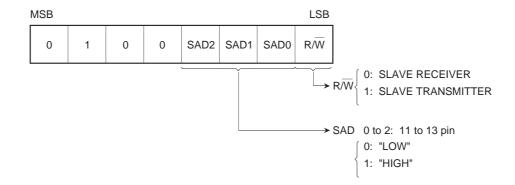


Test circuit 4



Definition of I²C Register

<Slave address>



<Register table>

- With the IC reset all registers are reset to 0
- *: Not defined
- x: Don't care
- Sub address is auto incremented
- It can be used as a 6-bit D/A converter by setting the lower two bits of DAC 0-4 registors to 0, but take care that the max. voltage of DA output will lower about 100 mV compared with the use of 8 bits.

Control Register

Sub address	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
××××× 000	REF	*	*	*	SW3	SW2	SW1	SW0
××××× 001				DAC	0 (8)			
××××× 010				DAC	1 (8)			
××××× 011	DAC2 (8)							
××××× 100	DAC3 (8)							
××××× 101	DAC4 (8)							

Status Register

BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
PONRES	0	0	0	ST3	ST2	ST1	ST0

<Registers> In brackets () number of bits

REF (1): Switches D/A converter reference voltage

0:Standardizes the inner regulator

1:Standardizes voltage resistance divided from Vcc

SW0 to 3 (1): Selects ON/OFF of Pins 1, 2, 9 and 10

(Each pin is the open collector output of NPN transistor)

0:OFF

1:ON

DAC0 to 4 (8): Digital data input register of D/A converter

0:Output voltage turns to minimum255:Output voltage turns to maximum

PONRES (1): Detects POWER ON RESET

0:Master passes from the bus and is reset to 0 after having read this status1:Set to 1 when power supply is turned on or when there has been a power dip

ST0 to 3 (1): Detects and registers the voltage condition of Pins 1, 2, 9 and 10

0:1.5 V and below

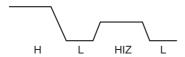
1:3.0 V and above

Note) SW0 to 3 effective during 0

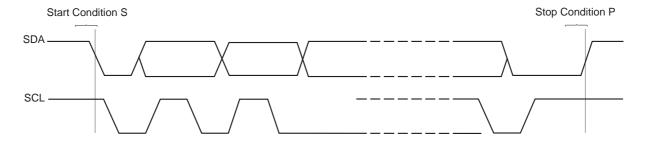
I²C Bus Signal

There are 2 signals in I²C bus. SDA (Serial DAta) and SCL (Serial Clock). SDA is double-way.

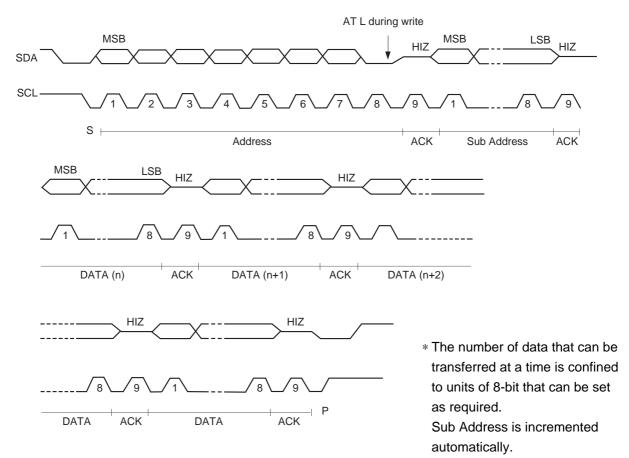
• As SDA is double-way it has 3 state outputs, H, L and HIZ.



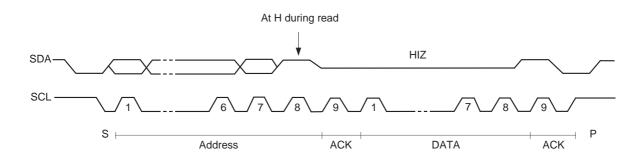
• I²C transfer begins with Start Condition and ends with Stop Condition.



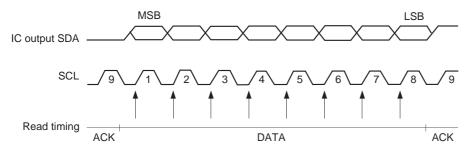
• I²C data write (Write from I²C controller to IC)



• I2C data read (Read from IC to I2C controller)

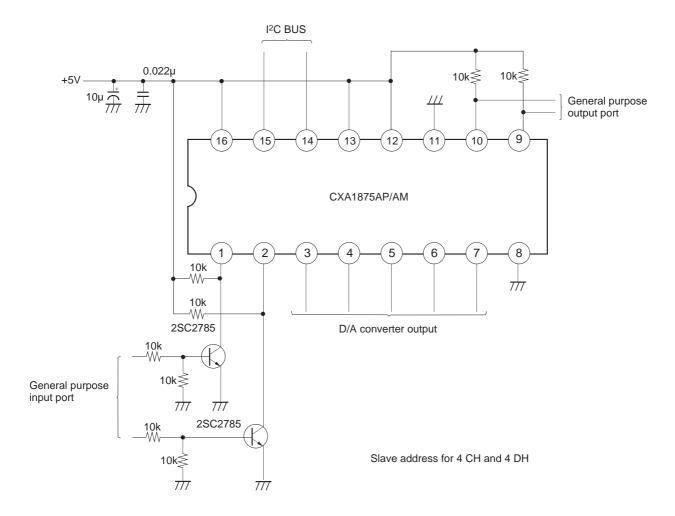


· Read timing



* Data read is performed with SCL rise.

Application Circuit



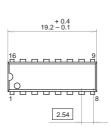
Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

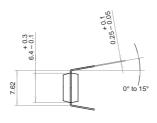
SONY

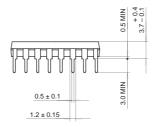
Package Outline Unit: mm

CXA1875AP

16PIN DIP (PLASTIC)







Two kinds of package surface:

1.All mat surface type.

2.All mirror surface type.

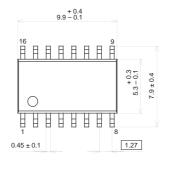
PACKAGE STRUCTURE

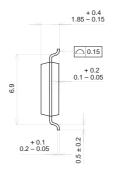
DIP-16P-01
DIP016-P-0300
Similar to MO-001-AE

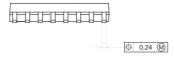
PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE MASS	1.0 g

CXA1875AM

16PIN SOP (PLASTIC)







PACKAGE STRUCTURE

SONY CODE	SOP-16P-L01
EIAJ CODE	SOP016-P-0300
JEDEC CODE	

d		
	PACKAGE MATERIAL	EPOXY RESIN
	LEAD TREATMENT	SOLDER PLATING
	LEAD MATERIAL	COPPER ALLOY
	PACKAGE MASS	0.2g

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